

# Agilent HLMP-CWxx T-1 ¾ (5mm) Extra Bright Precision Optical Performance White LED Lamps Data Sheet

**HLMP-CW11, HLMP-CW12, HLMP-CW26, HLMP-CW27,  
HLMP-CW36, HLMP-CW37**

## Description

These high intensity white LED lamps are based on InGaN material technology. A blue LED die is coated by phosphor to produce white. The typical resulting color is described by the coordinates  $x = 0.31$ ,  $y = 0.31$  using the 1931 CIE Chromaticity Diagram.

These T-1 ¾ lamps are untinted, non-diffused, and incorporate precise optics which produce well-defined spatial radiation patterns at specific viewing cone angle.

## Features

- Well defined spatial radiation pattern
- High luminous white emission
- Viewing angle: 15°, 23° and 30°
- Standoff or non-standoff leads
- Superior resistance to moisture

## Applications

- Electronic signs and signals
- Small area illumination
- Legend backlighting
- General purpose indicators

## Benefit

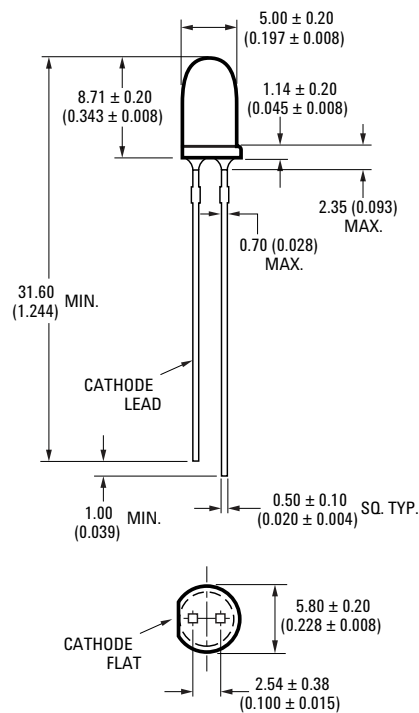
- Reduced power consumption, higher reliability, and increased optical/mechanical design flexibility compared to incandescent bulbs and other alternative white light sources.

*Caution: Devices are Class 1 ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.*

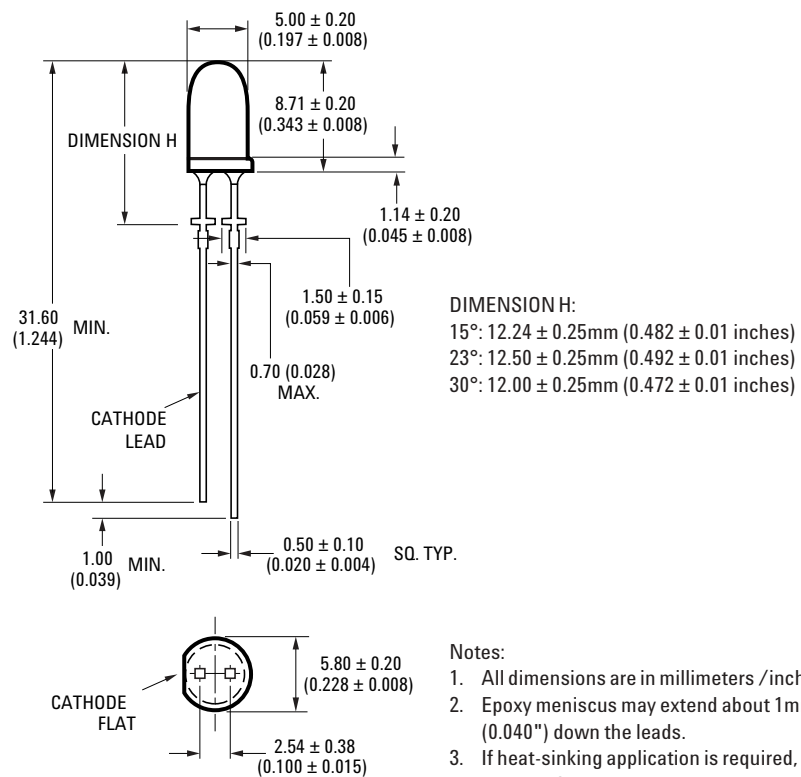


## Package Dimensions

### Package Dimension A



### Package Dimension B



#### Notes:

1. All dimensions are in millimeters /inches.
2. Epoxy meniscus may extend about 1mm (0.040") down the leads.
3. If heat-sinking application is required, the terminal for heat sink is anode.

## Part Numbering System

H L M P - CW XX - X X X XX

### Mechanical Option

- 00: Bulk
- DD: Ammo Pack Straight Leads

### Color Bin Options

- 0: Full color bin distribution
- B: Color bin 2 & 3 only

### Maximum Intensity Bin

- 0: No maximum intensity bin limit
- Others: Refer to Device Selection Guide

### Minimum Intensity Bin

- Refer to Device Selection Guide

### Viewing Angle and Standoff Option

- 11: 15° without standoff
- 12: 15° with standoff
- 26: 23° without standoff
- 27: 23° with standoff
- 36: 30° without standoff
- 37: 30° with standoff

## Device Selection Guide

Part Number	Typical Viewing Angle, $2\theta_{1/2}$ (Degree)	Intensity (mcd) at 20 mA		Standoff	Package Dimension
		Min.	Max.		
HLMP-CW11-WZ0xx	15	5500	16000	No	A
HLMP-CW11-XY0xx	15	7200	12000	No	A
HLMP-CW12-WZ0xx	15	5500	16000	Yes	B
HLMP-CW12-XY0xx	15	7200	12000	Yes	B
HLMP-CW12-XYBxx	15	7200	12000	Yes	B
HLMP-CW26-UX0xx	23	3200	9300	No	A
HLMP-CW26-VW0xx	23	4200	7200	No	A
HLMP-CW27-UX0xx	23	3200	9300	Yes	B
HLMP-CW27-UX2xx	23	3200	9300	Yes	B
HLMP-CW27-VW0xx	23	4200	7200	Yes	B
HLMP-CW36-TW0xx	30	2500	7200	No	A
HLMP-CW36-UV0xx	30	3200	5500	No	A
HLMP-CW36-UVBxx	30	3200	5500	No	A
HLMP-CW37-TW0xx	30	2500	7200	Yes	B
HLMP-CW37-UV0xx	30	3200	5500	Yes	B
HLMP-CW37-UVBxx	30	3200	5500	Yes	B

Notes:

1. Tolerance for luminous intensity measurement is +/- 15%
2. The luminous intensity is measured on the mechanical axis of the lamp package.
3. The optical axis is closely aligned with the package mechanical axis.
4. LED light output is bright enough to cause injuries to the eyes. Precautions must be taken to prevent looking directly at the LED without proper safety equipment.
5.  $2\theta_{1/2}$  is the off-axis angle where the luminous intensity is  $\frac{1}{2}$  the on axis intensity

## Absolute Maximum Rating at $T_A = 25^\circ\text{C}$

Parameters	Value	Unit
DC forward current <sup>[1]</sup>	30	mA
Peak pulsed forward current <sup>[3]</sup>	100	mA
Power dissipation	105	mW
LED junction temperature	110	°C
Operating temperature range	-40 to +85	°C
Storage temperature range	-40 to +100	°C
Wave soldering temperature <sup>[2]</sup>	250 for 3 seconds	°C
Solder Dipping temperature <sup>[2]</sup>	260 for 5 seconds	°C

Notes:

1. Derate linearly as shown in figure 2.
2. 1.59 mm (0.060 inch) below body
3. Duty factor 10%, frequency 1KHz

Electrical/Optical Characteristics T<sub>A</sub> = 25°C

Parameters	Symbol	Min	Typ	Max	Units	Test Condition
Forward voltage	V <sub>F</sub>		3.2	4.0	V	I <sub>F</sub> = 20 mA
Reverse Voltage <sup>[1]</sup>	V <sub>R</sub>	5.0			V	I <sub>R</sub> = 10 μA
Thermal resistance	Rθ <sub>J-PIN</sub>		240		°C/W	LED Junction to anode lead
Chromaticity Coordinates <sup>[2]</sup>	X		0.31			I <sub>F</sub> = 20 mA
	Y		0.31			
Capacitance	C		70			V <sub>F</sub> =0, f=1MHz

- Notes:
1. The reverse voltage of the product is equivalent to the forward voltage of the protective chip at I<sub>R</sub> = 10 μA
  2. The chromaticity coordinates are derived from the CIE 1931 Chromaticity Diagram and represent the perceived color of the device.

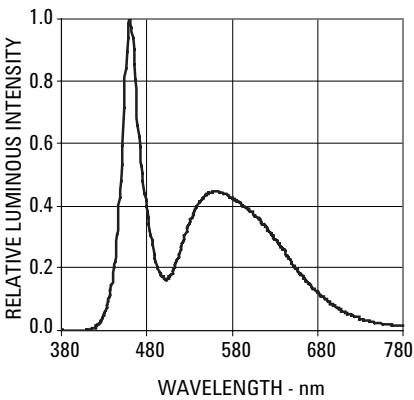


Figure 1. Relative Intensity vs. Wavelength

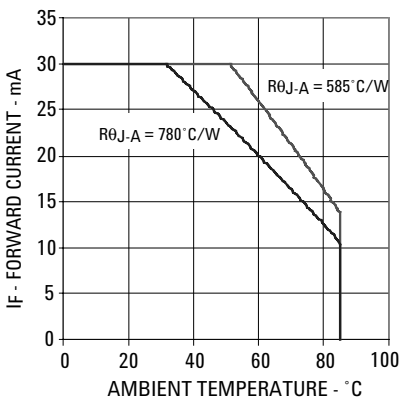


Figure 2. Forward Current vs. Ambient Temperature

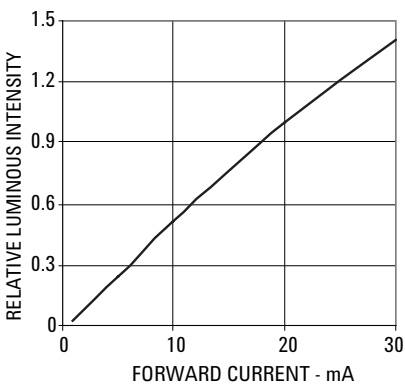


Figure 3. Relative Intensity versus DC Forward Current

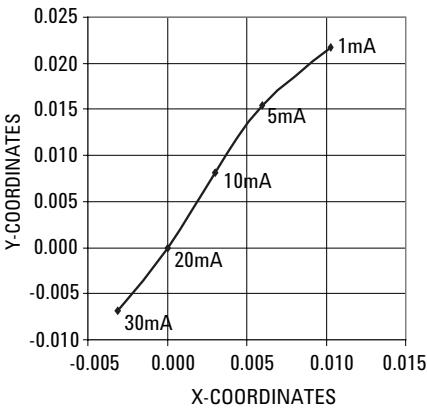


Figure 4. Chromaticity shift vs. Current

\*Note: (x,y) values @ 20mA reference to (0,0)

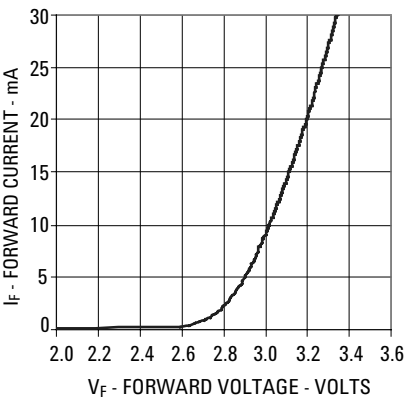


Figure 5. Forward Current vs. Forward Voltage

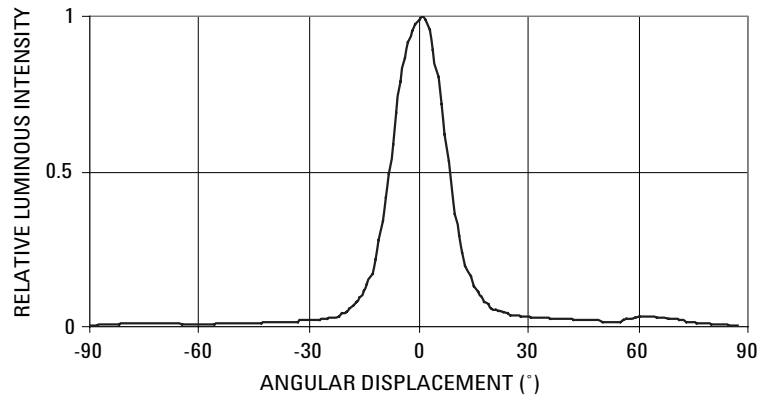


Figure 6. Spatial Radiation Pattern for CW1x

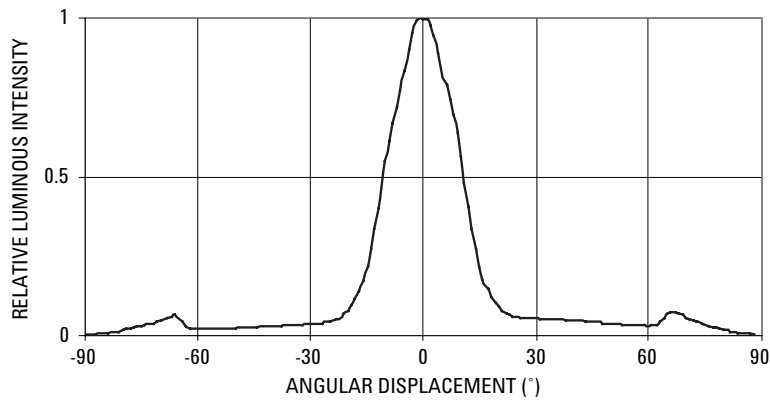


Figure 7. Spatial Radiation Pattern for CW2x

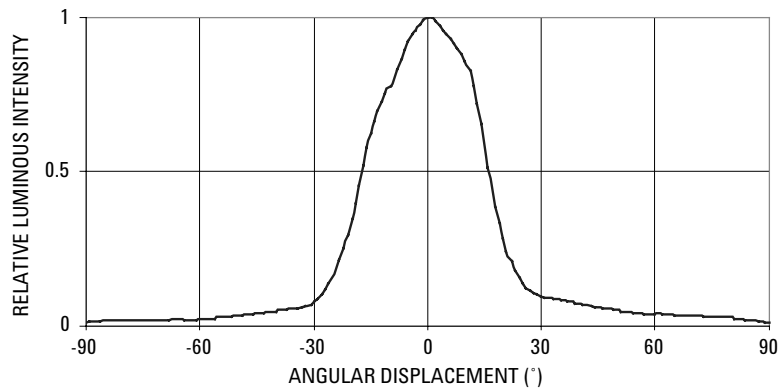


Figure 8. Spatial Radiation Pattern for CW3x

Intensity Bin Limit Table

Bin	Intensity (mcd) at 20 mA	
	Min	Max
Q	1150	1500
R	1500	1900
S	1900	2500
T	2500	3200
U	3200	4200
V	4200	5500
W	5500	7200
X	7200	9300
Y	9300	12000
Z	12000	16000
1	16000	21000

Tolerance for each bin limit is  $\pm 15\%$

**Color Bin Limit Table**

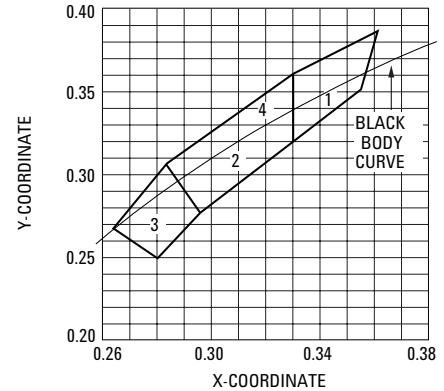
Rank	Limits (Chromaticity Coordinates)				
1	X	0.330	0.330	0.356	0.361
	Y	0.360	0.318	0.351	0.385
2	X	0.287	0.296	0.330	0.330
	Y	0.295	0.276	0.318	0.339
3	X	0.264	0.280	0.296	0.283
	Y	0.267	0.248	0.276	0.305
4	X	0.283	0.287	0.330	0.330
	Y	0.305	0.295	0.339	0.360

Tolerance for each bin limit is  $\pm 0.01$

Note:

1. Bin categories are established for classification of products. Products may not be available in all bin categories. Please contact your Agilent representative for information on currently available bins.

**Color Bin Limits with Respect to CIE 1931 Chromaticity Diagram**



**[www.agilent.com/semiconductors](http://www.agilent.com/semiconductors)**

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Data subject to change.

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